### 1.0 ELECTRICAL CHARACTERISTICS

### **Absolute Maximum Ratings†**

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	
Gate-to-Source Voltage	
Operating Ambient Temperature, T <sub>A</sub>	
Storage Temperature, T <sub>S</sub>	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

### DC ELECTRICAL CHARACTERISTICS

**Electrical Specifications:**  $T_A = 25^{\circ}$ C unless otherwise specified. All DC parameters are 100% tested at 25°C unless otherwise stated. Pulse test: 300 µs pulse, 2% duty cycle

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	-40	_	_	V	$V_{GS} = 0V$ , $I_D = -1$ mA
Gate Threshold Voltage	V <sub>GS(th)</sub>	<b>–</b> 1	_	-2	V	$V_{GS} = V_{DS}$ , $I_D = -1$ mA
Change in V <sub>GS(th)</sub> with Temperature	$\Delta V_{GS(th)}$	_	5.8	6.5	mV/°C	$V_{GS} = V_{DS}$ , $I_D = -1$ mA (Note 1)
Gate Body Leakage Current	I <sub>GSS</sub>		-1	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
				-10	μΑ	V <sub>GS</sub> = 0V, V <sub>DS</sub> = Maximum rating
Zero-Gate Voltage Drain Current	I <sub>DSS</sub>	ı		-1	mA	$V_{DS}$ = 0.8 Maximum rating, $V_{GS}$ = 0V, $T_A$ = 125°C (Note 1)
On-State Drain Current	I <sub>D(ON)</sub>	-0.6	_	_	Α	$V_{GS} = -10V, V_{DS} = -25V$
Static Drain-to-Source On-State Resistance	P	_		10	Ω	$V_{GS} = -4.5V$ , $I_{D} = -50$ mA
Static Drain-to-Source On-State Resistance	R <sub>DS(ON)</sub>			6	Ω	$V_{GS} = -10V$ , $I_{D} = -500$ mA
Change in R <sub>DS(ON)</sub> with Temperature	ΔR <sub>DS(ON)</sub>		0.55	1	%/°C	$V_{GS} = -10V, I_D = -500 \text{ mA}$ (Note 1)

**Note 1:** Specification is obtained by characterization and is not 100% tested.

## **AC ELECTRICAL CHARACTERISTICS**

Electrical Specifications: T <sub>A</sub> = 25°C unless otherwise specified	I. Specification is obtained by characterization and
is not 100% tested.	

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions					
Forward Transconductance	G <sub>FS</sub>	150	200	_	mmho	$V_{DS} = -25V$ , $I_{D} = -500$ mA					
Input Capacitance	C <sub>ISS</sub>	_	35	60	pF	$V_{GS} = 0V$ ,					
Common Source Output Capacitance	Coss	_	22	30	pF	$V_{DS} = -25V,$					
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	8	10	pF	f = 1 MHz					
Turn-On Delay Time	t <sub>d(ON)</sub>	_	4	6	ns						
Rise Time	t <sub>r</sub>	_	4	8	ns	$V_{DD} = -25V,$					
Turn-Off Delay Time	t <sub>d(OFF)</sub>	_	5	9	ns	$I_D = -500 \text{ mA},$ $R_{GEN} = 25\Omega$					
Fall Time	t <sub>f</sub>	_	5	8	ns	GEN					
DIODE PARAMETER	DIODE PARAMETER										
Diode Forward Voltage Drop	V <sub>SD</sub>		-1.2	-2	V	$V_{GS} = 0V$ , $I_{SD} = -500$ mA ( <b>Note 1</b> )					
Reverse Recovery Time	t <sub>rr</sub>	_	400	_	ns	$V_{GS} = 0V, I_{SD} = -500 \text{ mA}$					

**Note 1:** Unless otherwise stated, all DC parameters are 100% tested at 25°C. Pulse test: 300 μs pulse, 2% duty cycle

## **TEMPERATURE SPECIFICATIONS**

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Ambient Temperature	T <sub>A</sub>	-55	_	+150	°C	
Storage Temperature	T <sub>S</sub>	-55	_	+150	°C	
PACKAGE THERMAL RESISTANCE						
3-lead SOT-23	$\theta_{JA}$	_	203	_	°C/W	
3-lead TO-92	$\theta_{JA}$	_	132	_	°C/W	

## THERMAL CHARACTERISTICS

Package	I <sub>D</sub> (Note 1) (Continuous) (mA)	I <sub>D</sub> (Pulsed) (mA)	Power Dissipation at T <sub>A</sub> = 25°C (W)	I <sub>DR</sub> (Note 1) (mA)	I <sub>DRM</sub> (mA)
3-lead SOT-23	-160	-800	0.36	-160	-800
3-lead TO-92	<b>–175</b>	-1000	0.74	<b>–175</b>	-1000

Note 1:  $I_D$  (continuous) is limited by maximum rated  $T_J$ .

### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g. outside specified power supply range) and therefore outside the warranted range.

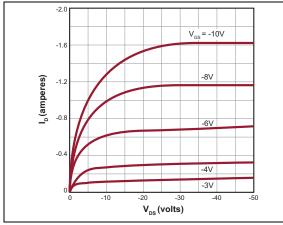
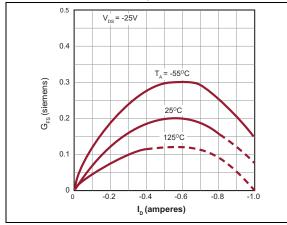
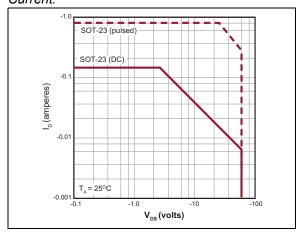


FIGURE 2-1: Output Characteristics.



**FIGURE 2-2:** Transconductance vs. Drain Current.



**FIGURE 2-3:** Maximum Rated Safe Operating Area.

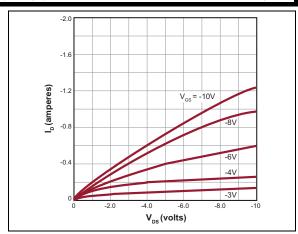


FIGURE 2-4: Saturation Characteristics.

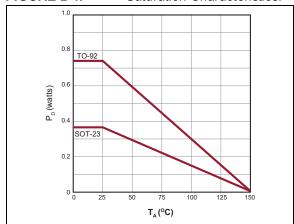


FIGURE 2-5: Power Dissipation vs. Case Temperature.

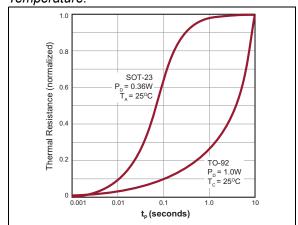


FIGURE 2-6: Thermal Response Characteristics.

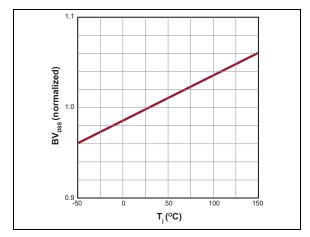


FIGURE 2-7: B
Temperature.

 $BV_{DSS}$  Variation with

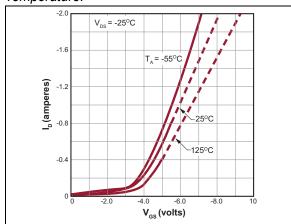
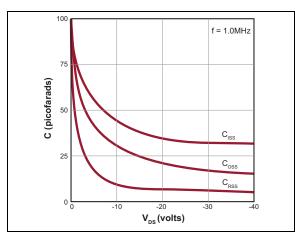


FIGURE 2-8: Transfer Characteristics.



**FIGURE 2-9:** Capacitance vs. Drain-to-Source Voltage.

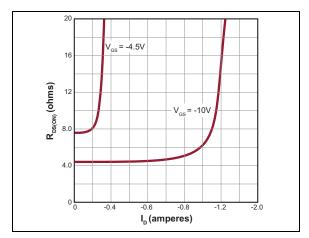


FIGURE 2-10: Current.

On-Resistance vs. Drain

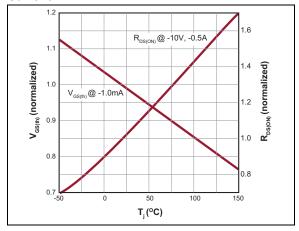


FIGURE 2-11: Temperature.

 $V_{(th)}$  and  $R_{DS}$  Variation with

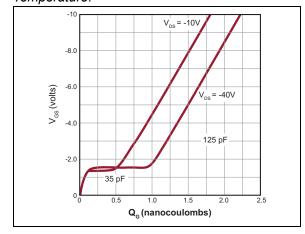


FIGURE 2-12: Characteristics.

Gate Drive Dynamic

# **TP2104**

### 3.0 PIN DESCRIPTION

The details on the pins of 3-lead-SOT-23 and 3-lead TO-92 are listed in Table 3-1 and Table 3-2, respectively. Refer to **Package Types** for the location of pins.

TABLE 3-1: 3-LEAD SOT-23 PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	Gate	Gate
2	Source	Source
3	Drain	Drain

### TABLE 3-2: 3-LEAD TO-92 PIN FUNCTION TABLE

Pin Number	Pin Name	Description					
1	Source	Source					
2	Gate	Gate					
3	Drain	Drain					

## 4.0 FUNCTIONAL DESCRIPTION

Figure 4-1 illustrates the switching waveforms and test circuit for TP2104.

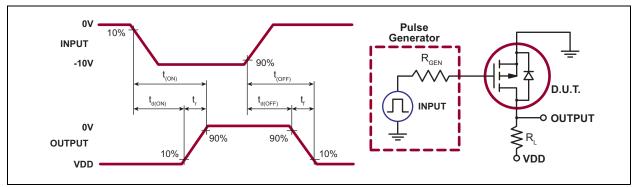


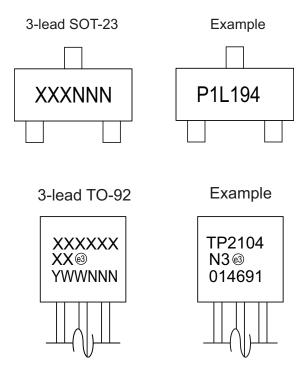
FIGURE 4-1: Switching Waveforms and Test Circuit.

TABLE 4-1: PRODUCT SUMMARY

BV <sub>DSS</sub> /BV <sub>DGS</sub> (V)	R <sub>DS(ON)</sub> (Maximum) (Ω)	V <sub>GS(TH)</sub> (Maximum) (V)
-40V	6	-2

### 5.0 PACKAGING INFORMATION

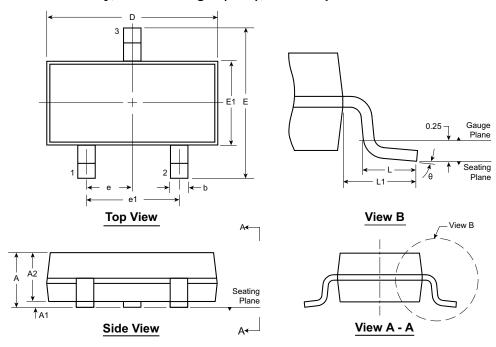
# 5.1 Package Marking Information



Legend: XX...X Product Code or Customer-specific information
Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
Pb-free JEDEC® designator for Matte Tin (Sn)
\* This package is Pb-free. The Pb-free JEDEC designator (e3)
can be found on the outer packaging for this package.

**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

# 3-Lead TO-236AB (SOT-23) Package Outline (K1/T) 2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

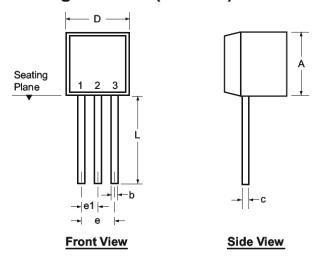
Symb	ol	Α	A1	A2	b	D	E	E1	е	e1	L	L1	θ		
<u>.</u> .	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.95 BSC	0.05	0.05	4.00	0.20 <sup>†</sup>	0.54	0°
Dimension (mm)	NOM	-	-	0.95	-	2.90	-	1.30		1.90 BSC	0.50	0.54 REF	-		
(11111)	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40	500	200	0.60	11	8°		

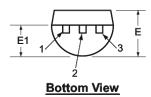
JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

Drawings not to scale.

<sup>†</sup> This dimension differs from the JEDEC drawing.

# 3-Lead TO-92 Package Outline (L/LL/N3)





Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbol		А	b	С	D	E	E1	е	e1	L
	MIN	.170	.014 <sup>†</sup>	.014 <sup>†</sup>	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
(51100)	MAX	.210	.022 <sup>†</sup>	.022†	.205	.165	.105	.105	.055	.610*

Drawings not to scale.

JEDEC Registration TO-92
\* This dimension is not specified in the JEDEC drawing.
† This dimension differs from the JEDEC drawing.

## APPENDIX A: REVISION HISTORY

## Revision A (April 2020)

- Converted Supertex Doc# DSFP-TP2104 to Microchip DS20005958A
- · Added pin function tables
- · Changed the package marking format
- Removed the TO-92 P002, P005, P013 and P014 media types
- Made minor text changes throughout the document

# PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO	<u>. xx</u>		- <u>X</u> - <u>X</u>	Examples:	
Device	Packa Optio	_	Environmental Media Type	a) TP2104N3-G:	P-Channel Enhancement- Mode, Vertical DMOS FET, 3-lead TO-92, 1000/Bag
Device:	TP2104	=	P-Channel Enhancement-Mode Vertical DMOS FET	b) TP2104N3-G-P003:	P-Channel Enhancement- Mode, Vertical DMOS FET, 3-lead TO-92, 2000/Reel
Packages:	N3	=	3-lead TO-92		
	K1	=	3-lead SOT-23	c) TP2104K1-G:	P-Channel Enhancement- Mode, Vertical DMOS FET, 3-lead SOT-23, 3000/Reel
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Types:	(blank)	=	1000/Bag for an N3 Package		
	(blank)	=	3000/Reel for a K1 Package		
	P003	=	2000/Reel for an N3 Package		

### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

#### **Trademarks**

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackeTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TempTrackr, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, Vite, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAuthentication, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2020, Microchip Technology Incorporated, All Rights Reserved.

ISBN:978-1-5224-5891-3

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



# **Worldwide Sales and Service**

### **AMERICAS**

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199

Tel: 480-792-7200 Fax: 480-792-7277 Technical Support:

http://www.microchip.com/ support

Web Address:

www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

**Austin, TX** Tel: 512-257-3370

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

**Dallas** Addison, TX Tel: 972-818-7423

Fax: 972-818-2924 **Detroit** 

Novi, MI

Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380 **Los Angeles** 

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

**Raleigh, NC** Tel: 919-844-7510

New York, NY Tel: 631-435-6000

**San Jose, CA** Tel: 408-735-9110 Tel: 408-436-4270

**Canada - Toronto** Tel: 905-695-1980 Fax: 905-695-2078

### ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

**China - Beijing** Tel: 86-10-8569-7000

China - Chengdu Tel: 86-28-8665-5511

**China - Chongqing** Tel: 86-23-8980-9588

**China - Dongguan** Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

**China - Nanjing** Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

**China - Shenyang** Tel: 86-24-2334-2829

**China - Shenzhen** Tel: 86-755-8864-2200

**China - Suzhou** Tel: 86-186-6233-1526

**China - Wuhan** Tel: 86-27-5980-5300

China - Xian

Tel: 86-29-8833-7252 China - Xiamen

Tel: 86-592-2388138

**China - Zhuhai** Tel: 86-756-3210040

### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631

India - Pune Tel: 91-20-4121-0141

**Japan - Osaka** Tel: 81-6-6152-7160

**Japan - Tokyo** Tel: 81-3-6880- 3770

Korea - Daegu

Tel: 82-53-744-4301 **Korea - Seoul** Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

**Singapore** Tel: 65-6334-8870

**Taiwan - Hsin Chu** Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

**Taiwan - Taipei** Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

### **EUROPE**

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

**Denmark - Copenhagen** Tel: 45-4485-5910 Fax: 45-4485-2829

Finland - Espoo Tel: 358-9-4520-820

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Garching Tel: 49-8931-9700

**Germany - Haan** Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-72400

**Germany - Karlsruhe** Tel: 49-721-625370

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

**Netherlands - Drunen** Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7288-4388

**Poland - Warsaw** Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

**Sweden - Gothenberg** Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

**UK - Wokingham** Tel: 44-118-921-5800 Fax: 44-118-921-5820